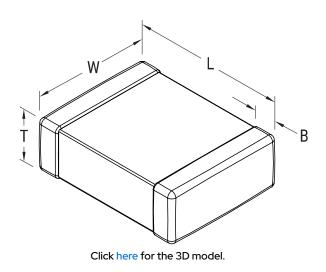




CBR-SMD RF COG, Ceramic, 91 pF, 5%, 50 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0603



General Information		
Series	CBR-SMD RF COG	
Style	SMD Chip	
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I	
Features	Ultra High Q, Low ESR, Class I	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	5.29 mg	
Notes	Solder Wave or Solder Reflow.	
Shelf Life	78 Weeks	
MSL	1	

91 pF

Dimensions	
Chip Size	0603
L	1.6mm +/-0.1mm
W	0.8mm +/-0.1mm
T	0.8mm +/-0.07mm
В	0.4mm +/-0.15mm

L	1.6mm +/-0.1mm	Tolerance	5%
W	0.8mm +/-0.1mm	Voltage DC	50 VDC
Т	0.8mm +/-0.07mm	Dielectric Withstanding Voltage	125 VDC
В	0.4mm +/-0.15mm	Temperature Range	-55/+125°C
		Temp. Coefficient	COG
Packaging Specifications		Aging Rate	0% Loss/Decade Hour
Packaging	T&R, 180mm, Plastic Tape	Insulation Resistance	10 GOhms
Packaging Quantity	4000	Quality Factor	1000

Specifications Capacitance

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and
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